

# **ESD Protection Diode**

# **Dual Line Automotive Bus Protector**

# **NUP2125, SZNUP2125**

The SZ/NUP2125 has been designed to protect both CAN and LIN transceivers from ESD and other harmful transient voltage events. This device provides bidirectional protection for each data line with a single compact SC-70 (SOT-323) package, giving the system designer a low cost option for improving system reliability and meeting stringent EMI requirements.

#### **Features**

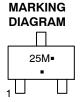
- 200 W Peak Power Dissipation per Line (8/20 μs Waveform)
- Diode Capacitance Matching
- Low Reverse Leakage Current (< 100 nA)
- IEC Compatibility: IEC 61000-4-2 (ESD): Level 4
  - IEC 61000-4-4 (EFT): 50 A 5/50 ns
  - IEC 61000-4-5 (Lighting) 3.0 A (8/20 μs)
- ISO 7637–1, Nonrepetitive EMI Surge Pulse 2, 8.0 A (1/50 μs)
- ISO 7637–3, Repetitive Electrical Fast Transient (EFT) EMI Surge Pulses, 50 A (5/50 ns)
- Flammability Rating UL 94 V-0
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are Pb-Free Devices

#### **Applications**

- Automotive Networks
  - CAN / CAN-FD
  - Low and High-Speed CAN
  - Fault Tolerant CAN
  - LIN



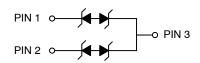
SC-70 CASE 419

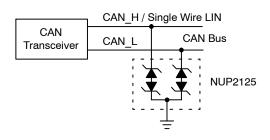


25 = Specific Device Code M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)





#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

# **NUP2125, SZNUP2125**

# **MAXIMUM RATINGS** ( $T_J = 25^{\circ}C$ , unless otherwise specified)

Symbol	Rating	Value	Unit
PPK	Peak Power Dissipation, 8/20 μs Double Exponential Waveform (Note 1)	200	W
T <sub>J</sub>	Operating Junction Temperature Range	-55 to 150	°C
TJ	Storage Temperature Range	-55 to 150	°C
T <sub>L</sub>	Lead Solder Temperature (10 s)	260	°C
ESD	Human Body Model (HBM) Machine Model (MM) IEC 61000–4–2 Contact IEC 61000–4–2 Air ISO 10605 150 pF / 2 k $\Omega$ Contact ISO 10605 330 pF / 2 k $\Omega$ Contact	±8.0 ±1.6 ±30 ±30 ±30 ±30	kV kV kV kV kV

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25°C, unless otherwise specified)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V <sub>RWM</sub>	Reverse Working Voltage	(Note 2)	24	-	-	V
V <sub>BR</sub>	Breakdown Voltage	I <sub>T</sub> = 1 mA (Note 3)	27	28.5	32	V
I <sub>R</sub>	Reverse Leakage Current	V <sub>RWM</sub> = 24 V	-	15	100	nA
V <sub>C</sub>	Clamping Voltage	I <sub>PP</sub> = 1 A (8/20 μs Waveform) (Note 4)	-	33.4	36.6	V
V <sub>C</sub>	Clamping Voltage	I <sub>PP</sub> = 3 A (8/20 μs Waveform) (Note 4)	-	44	50	٧
I <sub>PP</sub>	Maximum Peak Pulse Current	8/20 μs Waveform (Note 4)	-	-	3.0	Α
CJ	Capacitance	V <sub>R</sub> = 0 V, f = 1 MHz (Line to GND)	-	7.0	10	рF
		V <sub>R</sub> = 5 V, f = 1 MHz (Line to GND)	-	4.5	6.0	рF
		$V_R$ = 5 V, f = 1 MHz (Line to GND), $T_A$ = +150°C	-	5.0	-	pF
ΔC	Diode Capacitance Matching	V <sub>R</sub> = 0 V, 5 MHz (Note 5)	-	0.26	2	%

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>	
NUP2125WTT1G		2000 / Tana & Daal	
SZNUP2125WTT1G*	SC-70	3000 / Tape & Reel	
NUP2125WTT3G	(Pb-Free)	10000 / Tana % Dool	
SZNUP2125WTT3G*		10000 / Tape & Reel	

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

<sup>1.</sup> Non-repetitive current pulse per Figure 1.

Surge protection devices are normally selected according to the working peak reverse voltage (V<sub>RWM</sub>), which should be equal or greater than the DC or continuous peak operating voltage level.

<sup>3.</sup> V<sub>BR</sub> is measured at pulse test current I<sub>T</sub>.

<sup>4.</sup> Pulse waveform per Figure 1.

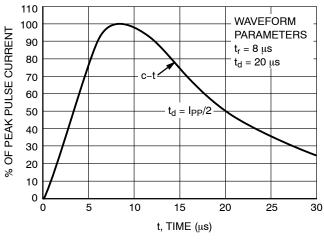
ΔC is the percentage difference between C<sub>J</sub> of lines 1 and 2 measured according to the test conditions given in the electrical characteristics table.

<sup>\*</sup>SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

## NUP2125, SZNUP2125

## **TYPICAL PERFORMANCE CURVES**

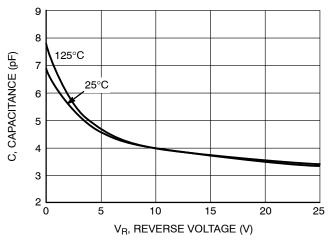
(T<sub>J</sub> = 25°C UNLESS OTHERWISE NOTED)



3.5 € 3.0 IPP, PEAK PULSE CURRENT 2.5 2.0 1.5 1.0 0.5 0.0 35 30 40 45 50 V<sub>C</sub>, CLAMPING VOLTAGE (V)

Figure 1. Pulse Waveform,  $8/20~\mu s$ 

Figure 2. Clamping Voltage vs Peak Pulse Current



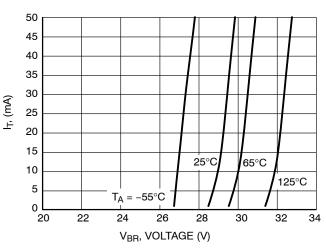
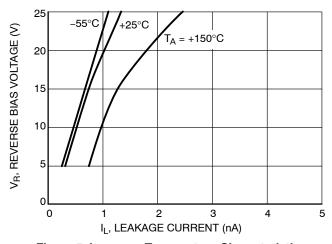


Figure 3. Typical Junction Capacitance vs Reverse Voltage

Figure 4. V<sub>BR</sub> versus I<sub>T</sub> Characteristics



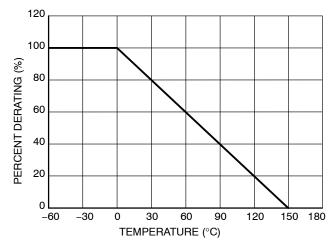


Figure 5.  $I_R$  versus Temperature Characteristics

Figure 6. Temperature Power Dissipation Derating

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#### **Surge Protection Diode Circuit**

Surge protection diodes provide protection to a transceiver by clamping a surge voltage to a safe level. Surge protection diodes have high impedance below and low impedance above their breakdown voltage. A surge protection Zener diode has its junction optimized to absorb the high peak energy of a transient event, while a standard Zener diode is designed and specified to clamp a steady state voltage.

Figure 7 provides an example of a dual bidirectional surge protection diode array that can be used for protection with the high-speed CAN network. The bidirectional array is created from four identical Zener TVS diodes. The clamping voltage of the composite device is equal to the

breakdown voltage of the diode that is reversed biased, plus the diode drop of the second diode that is forwarded biased.

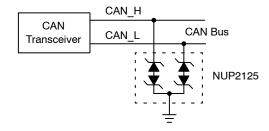


Figure 7. High-Speed and Fault Tolerant CAN Surge Protection Circuit





SC-70 (SOT-323) **CASE 419** ISSUE R

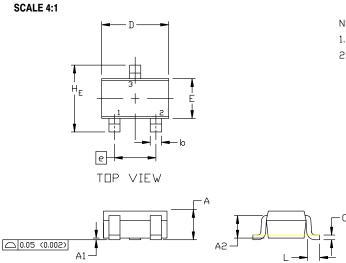
END VIEW

**DATE 11 OCT 2022** 

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH

	MILLIMETERS			INCHES		
DIM	MIN.	N□M.	MAX.	MIN.	N□M.	MAX.
Α	0.80	0.90	1.00	0.032	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A2	0.70 REF			0.028 BSC		
b	0.30	0.35	0.40	0.012	0.014	0.016
С	0.10	0.18	0.25	0.004	0.007	0.010
D	1.80	2.00	2.20	0.071	0.080	0.087
E	1.15	1.24	1.35	0.045	0.049	0.053
е	1.20	1.30	1.40	0.047	0.051	0.055
e1	0.65 BSC			0.026 BSC		
L	0.20	0.38	0.56	0.008	0.015	0.022
HE	2.00	2.10	2.40	0.079	0.083	0.095



### **GENERIC MARKING DIAGRAM**

SIDE VIEW

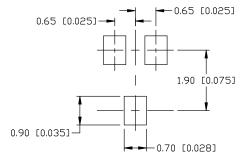


= Specific Device Code XX

Μ = Date Code

= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.



For additional information on our Pb-Free strategy and soldering details, please download the ID Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

SOLDERING FOOTPRINT

STYLE 1: CANCELLED	STYLE 2: PIN 1. ANODE 2. N.C. 3. CATHODE	STYLE 3: PIN 1. BASE 2. EMITTER 3. COLLECTOR	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. CATHODE	
STYLE 6: PIN 1. EMITTER	STYLE 7: PIN 1. BASE	STYLE 8: PIN 1. GATE	STYLE 9: PIN 1. ANODE	STYLE 10: PIN 1. CATHODE	STYLE 11: PIN 1. CATHODE
2. BASE	2. EMITTER	2. SOURCE	2. CATHODE	2. ANODE	2. CATHODE
<ol><li>COLLECTOR</li></ol>	<ol><li>COLLECTOR</li></ol>	3. DRAIN	<ol><li>CATHODE-ANODE</li></ol>	3. ANODE-CATHODE	<ol><li>CATHODE</li></ol>

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Europe, Middle East and Africa Technical Support:

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